Triacs logic level

BT137B series D

GENERAL DESCRIPTION

Glass passivated, sensitive gate triacs in a plastic envelope suitable for surface mounting, intended for use in general purpose bidirectional switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

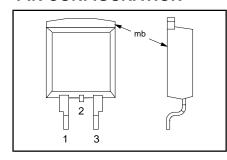
QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | MAX. | UNIT |
|---|---|-------------------------------|------------------------|-------------|
| V _{DRM} I _{T(RMS)} I _{TSM} | BT137B- Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current | 500D 500 8 65 | 600D 600 8 65 | V A A |

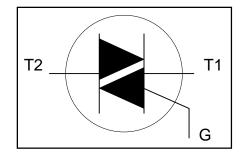
PINNING - SOT404

| PIN | DESCRIPTION |
|-----|-----------------|
| 1 | main terminal 1 |
| 2 | main terminal 2 |
| 3 | gate |
| mb | main terminal 2 |

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|--|---|--|----------|--|-----------------------|
| V_{DRM} | Repetitive peak off-state voltages | | - | -500 -600 500 ¹ 600 ¹ | \ \ |
| I _{T(RMS)} | RMS on-state current Non-repetitive peak on-state current | full sine wave; $T_{mb} \le 102 ^{\circ}\text{C}$ full sine wave; $T_{j} = 25 ^{\circ}\text{C}$ prior to surge | - | 8 | A |
| | | t = 20 ms t = 16.7 ms | _ | 65 71 | Α |
| l²t dl _⊤ /dt | I ² t for fusing Repetitive rate of rise of on-state current after | t = 10.7 ms t = 10 ms $I_{TM} = 12 \text{ A}; I_{G} = 0.2 \text{ A};$ $dI_{G}/dt = 0.2 \text{ A}/\mu\text{s}$ | - | 21 | A A ² s |
| | triggering | T2+ G+ | - | 50 | A/μs |
| | | T2+ G- T2- G- | _ | 50 50 | A/μs A/μs |
| | | T2- G+ | _ | 10 | A/μs |
| I _{GM} V _{GM} P _{GM} | Peak gate current Peak gate voltage Peak gate power | | - - | 2 5 5 | A V W |
| $\begin{array}{c} P_{GM} \\ P_{G(AV)} \\ T_{stg} \\ T_{j} \end{array}$ | Average gate power Storage temperature Operating junction temperature | over any 20 ms period | -40 - | 0.5 150 125 | ეე°, |

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¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 6 A/µs.

BT137B series D

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--|------------------------------|------|------|------------|------------|
| | Thermal resistance junction to mounting base | full cycle half cycle | 1 1 | ! | 2.0 2.4 | K/W K/W |
| R _{th j-a} | Thermal resistance junction to ambient | minimum footprint, FR4 board | - | 55 | - | K/W |

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
|------------------|---------------------------|---|--------------------|------|------|--------|------|
| I _{GT} | Gate trigger current | $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$ | | | | | |
| | | | 2+ G+ | - | 2.5 | 5 | mΑ |
| | | T | 2+ G- | - | 3.5 | 5 5 | mΑ |
| | | | ⁻ 2- G- | - | 3.5 | | mΑ |
| | | | ⁻ 2- G+ | - | 6.5 | 10 | mΑ |
| I _L | Latching current | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$ | | | | | |
| | | | T2+ G+ | - | 1.6 | 15 | mΑ |
| | | - | ⁻ 2+ G- | - | 8.5 | 20 | mΑ |
| | | | 2- G- | - | 1.2 | 15 | mΑ |
| | | - | ⁻ 2- G+ | - | 2.5 | 20 | mA |
| l I _H | Holding current | $V_D = 12 V; I_{GT} = 0.1 A$ | | - | 1.5 | 10 | mΑ |
| V _T | On-state voltage | $I_{T} = 10 \text{ A}$ | | - | 1.3 | 1.65 | V |
| V _{GT} | Gate trigger voltage | $\begin{vmatrix} \dot{V}_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A} \\ V_{D} = 400 \text{ V}; I_{T} = 0.1 \text{ A}; T_{i} = 125 ^{\circ}\text{C}$ | _ | - | 0.7 | 1.5 | V |
| | l | $ V_D = 400 \text{ V}; I_T = 0.1 \text{ A}; T_L = 125 ^{\circ}\text{C}$ |) | 0.25 | 0.4 | | V |
| I_{D} | Off-state leakage current | $V_D = V_{DRM(max)}$; $T_j = 125$ °C | | - | 0.1 | 0.5 | mA |

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------------|--|---|------|------|------|------|
| dV _D /dt | Critical rate of rise of | $V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$ | - | 5 | - | V/μs |
| t _{gt} | off-state voltage Gate controlled turn-on time | exponential waveform; $R_{GK} = 1 \text{ k}\Omega$ $I_{TM} = 12 \text{ A}$; $V_D = V_{DRM(max)}$; $I_G = 0.1 \text{ A}$; $dI_G/dt = 5 \text{ A}/\mu\text{s}$ | - | 2 | - | μs |

Triacs logic level

BT137B series D

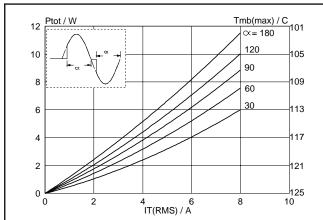


Fig.1. Maximum on-state dissipation, P_{tot} , versus rms on-state current, $I_{T(RMS)}$, where α = conduction angle.

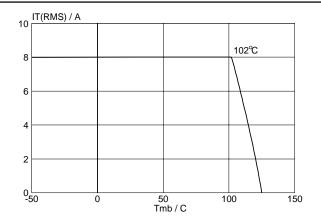


Fig.4. Maximum permissible rms current $I_{T(RMS)}$, versus mounting base temperature T_{mb} .

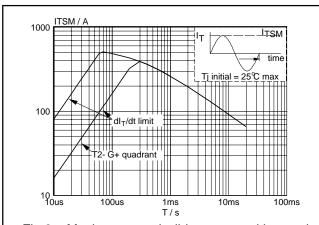


Fig.2. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus pulse width t_p , for sinusoidal currents, $t_p \le 20$ ms.

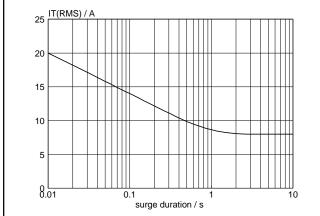


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{mb} \le 102$ °C.

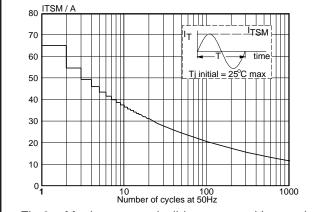


Fig.3. Maximum permissible non-repetitive peak on-state current I_{TSM} , versus number of cycles, for sinusoidal currents, f = 50 Hz.

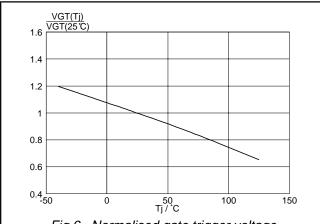
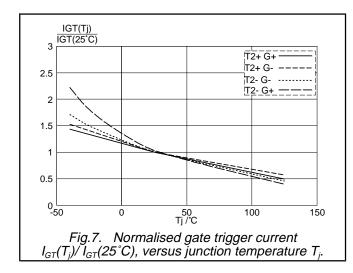
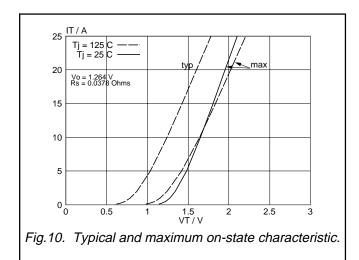
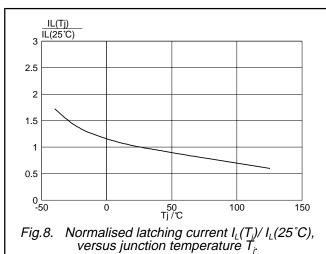
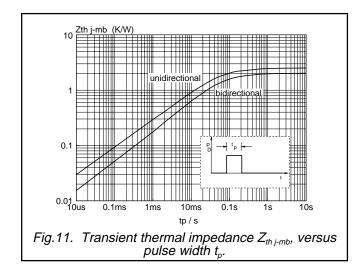


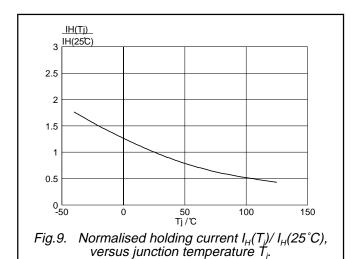
Fig.6. Normalised gate trigger voltage $V_{GT}(T_j)/V_{GT}(25\,^{\circ}C)$, versus junction temperature T_j .











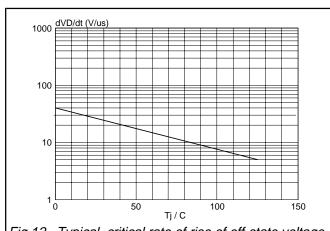


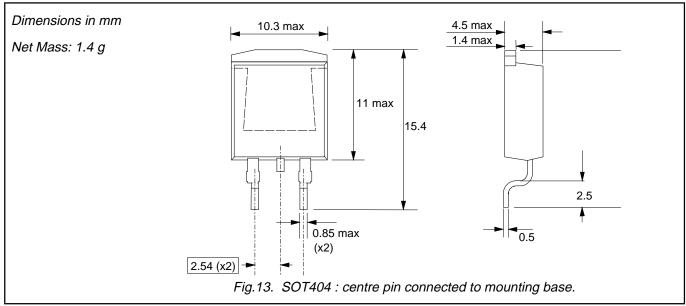
Fig.12. Typical, critical rate of rise of off-state voltage, dV_D/dt versus junction temperature T_i.

Philips Semiconductors Product specification

Triacs logic level

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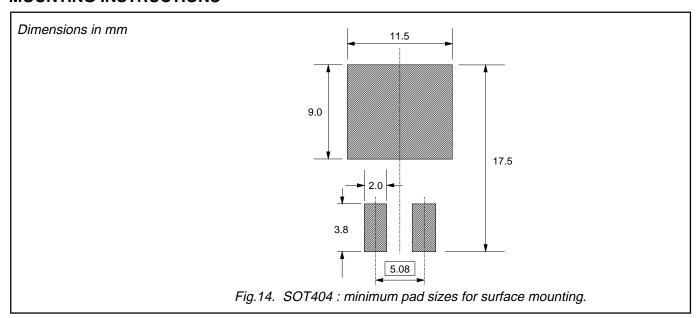
MECHANICAL DATA



Notes

1. Epoxy meets UL94 V0 at 1/8".

MOUNTING INSTRUCTIONS



Notes

1. Plastic meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Triacs logic level

BT137B series D

DEFINITIONS

| Data sheet status | | | | | | |
|---|--|--|--|--|--|--|
| This data sheet contains target or goal specifications for product development. | | | | | | |
| This data sheet contains preliminary data; supplementary data may be published later. | | | | | | |
| This data sheet contains final product specifications. | | | | | | |
| İ | | | | | | |

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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